PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	STMicroelectronics International N.V	
1.2 PCN No.	ADG/19/11732	
1.3 Title of PCN	I2PAK, TO-220, TO-247 New Molding Compound Shenzhen (China) - Bouskoura (Marocco) AUTOMOTIVE	
1.4 Product Category	Power MOSFET Power BIPOLAR	
1.5 Issue date	2019-08-30	

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	ROBERTSON HEATHER	
2.1.2 Phone	+1 8475853058	
2.1.3 Email	heather.robertson@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Mario ASTUTI, Maurizio GIUDICE, Angelo RAO, Nicola LIPORACE	
2.1.2 Marketing Manager	Anna MOTTESE, Michele SCUTO, Giuseppe BAZZANO	
2.1.3 Quality Manager	Vincenzo MILITANO, Francesco MINERVA	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials		BOUSKOURA B/E (Morocco) SHENZHEN (China)

4. Description of change		
	Old	New
4.1 Description		Replacement of current mold compounds with alternative material. ST is already proceeding with new resins evaluation and qualification, to guarantee adequate products continuity.
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impacts	

5. Reason / motivation for change		
5.1 Motivation	Product discontinuance from current supplier	
5.2 Customer Benefit	SERVICE CONTINUITY	

6. Marking of parts / traceability of change	
6.1 Description	by FG code and Q.A. number

7. Timing / schedule	
7.1 Date of qualification results	2019-08-22
7.2 Intended start of delivery	2020-03-30
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation			
8.1 Description	11732 Rel18-2019.pdf		
8.2 Qualification report and qualification results		Issue Date	2019-08-30

11732 Public product.pdf 11732 New Molding compound - AUT.pdf 11732 Rel18-2019.pdf

10. Affected parts			
10. 1 Current		10.2 New (if applicable)	
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No	
497-3128-5-ND	BU931P		
BU931P	BU931P		
497-2797-5-ND	BU931T		
BU931T	BU931T		
497-2740-5-ND	BU941ZT		
BU941ZT	BU941ZT		
	STB80NF55-06-1		
	STI300N4F6		
	STP120N4F6		
	STP141NF55		
	STP150NF55		
	STP190N55LF3		
	STP315N10F7		
	STP36NF06L		
	STP45N40DM2AG		
	STP45N60DM2AG		
	STP46NF30		
497-3202-5-ND	STP80NF55-08		
	STP80NF55-08AG		
	STW19NM60N		
	STW22N95K5		
	STW36NM60ND		
	STW37N60DM2AG		
	STW45N60DM2AG		
	STW46NF30		
	STW50N65DM2AG		
	STW58N60DM2AG		
	STW58N65DM2AG		
	STW62N65M5		
	STW65N65DM2AG		
	STW72N60DM2AG		
	STW78N65M5		



Public Products List

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title : I2PAK, TO-220, TO-247 New Molding Compound Shenzhen (China) - Bouskoura (Marocco) AUTOMOTIVE *PCN Reference :* ADG/19/11732

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STP315N10F7	STI47N60DM6AG	STP120N4F6	
STP100NF04	STW58N60DM2AG	STW19NM60N	
STW65N65DM2AG	STW78N65M5	STP180NS04ZC	
STP80NF55-08AG	STP95N4F3	STP45N40DM2AG	
STW50N65DM2AG	STW36N60DM6AG	STI270N4F3	
STW47N60DM6AG	STP150NF55	STP80NF55-08	
STP410N4F7AG	STI55NF03L	STW58N65DM2AG	
BU941ZT	STI300N4F6	STP141NF55	
STW22N95K5	BU931P	STB130NS04ZB-1	
STW46NF30	STB80NF55-06-1	STW62N65M5	
STP76NF75	STP85NF55	STW72N60DM2AG	
STP36NF06L	BU931T	STW37N60DM2AG	
STI76NF75	STP185N55F3	STP46NF30	
STW45N60DM2AG	STP150NF04	STP80N6F6	
STP190N55LF3	STP45N60DM2AG		

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